

Innovating Energy Technology

http://www.fujielectric.com/products/semiconductor/ **FUJI POWER MOSFET**

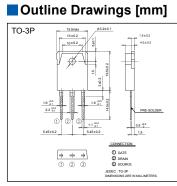
Super J-MOS series

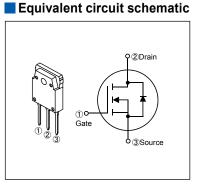
N-Channel enhancement mode power MOSFET

Features

Pb-free lead terminal **RoHS** compliant

Applications For switching





Absolute Maximum Ratings at Tc=25°C (unless otherwise specified)

Parameter	Symbol	Characteristics	Unit	Remarks
Drain Source Voltage	VDS	600	V	
Drain-Source Voltage	VDSX	600	V	V _{GS} =-30V
Continuous Drain Current		±20	А	Tc=25°C Note*1
	ID	±12.6	А	Tc=100°C Note*1
Pulsed Drain Current	IDP	±60	А	Note*1
Gate-Source Voltage	V _{GS}	±30	V	
Repetitive and Non-Repetitive Maximum Avalanche Current	lar	6.6	А	Note *2
Non-Repetitive Maximum Avalanche Energy	Eas	472.2	mJ	Note *3
Maximum Drain-Source dV/dt	dV _{DS} /dt	50	kV/µs	V _{DS} ≤ 600V
Peak Diode Recovery dV/dt	dV/dt	30	kV/µs	Note *4
Peak Diode Recovery -di/dt	-di/dt	100	A/µs	Note *5
Maximum Bower Discipation	P	2.5	W	T _a =25°C
Maximum Power Dissipation	F D	140	vv	Tc=25°C
Operating and Storage Temperature range	Tch	150	°C	
Operating and Storage Temperature range	T _{stg}	-55 to +150	°C	

Note *1 : Limited by maximum channel temperature. Note *2 : Tch≤150°C, See Fig.1 and Fig.2 Note *3 : Starting Tch=25°C, IAs=2A, L=216mH, Voo=60V, RG=50Ω, See Fig.1 and Fig.2

EAs limited by maximum channel temperature and avalanche current. Note *4 : Ir≤-ID, -di/dt=100A/µs, VDs peak≤600V, Tch≤150°C.

Note *5 : IF≤-ID, dV/dt=30kV/µs, VDS peak≤600V, Tch≤150°C.

Electrical Characteristics at T_c=25°C (unless otherwise specified) Static Ratings

Parameter	Symbol	Conditions		min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	l₀=250μA V _{GS} =0V		600	-	-	V
Gate Threshold Voltage	V _{GS(th)}	I₀=250µA V₀s=V₀s		3	4	5	V
Zero Gate Voltage Drain Current	IDSS	V _{DS} =600V V _{GS} =0V	T _{ch} =25°C	-	-	25	μA
		V _{DS} =480V V _{GS} =0V	T _{ch} =125°C	-	100	-	
Gate-Source Leakage Current	IGSS	V _{GS} = ± 30V V _{DS} =0V		-	10	100	nA
Drain-Source On-State Resistance	R _{DS(on)}	I₀=10A V₀s=10V		-	0.168	0.2	Ω
Gate resistance	RG	f=1MHz, open drain		-	3.7	-	Ω

Dynamic Ratings

Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Forward Transconductance	g fs	I _D =10A V _{DS} =25V	8	16	-	S
Input Capacitance	Ciss	V _{DS} =400V	-	1370	-	
Output Capacitance	Coss	V _{GS} =0V	-	40	-	
Reverse Transfer Capacitance	Crss	f=250kHz	-	3	-	
Effective output capacitance, energy related (Note *6)	C _{o(er)}	V _{GS} =0V V _{DS} =0400V	-	115	-	pF
Effective output capacitance, time related (Note *7)	C _{o(tr)}	$V_{GS}=0V$ $V_{DS}=0400V$ ID=constant	-	365	-	
Turn On Time	t _{d(on)}		-	80	-	
Turn-On Time	tr	V_{DD} =400V, V_{GS} =10V	-	27	-	ns
Turn Off Time	t _{d(off)}	_ I⊳=10A, R₀=27Ω _ See Fig.3 and Fig.4	-	124	-	
Turn-Off Time	tr		-	19	-	
Total Gate Charge	QG	V₀₀=400V, I₀=20A V₀₅=10V See Fig.5	-	52	-	nC
Gate-Source Charge	Q _{GS}		-	16	-	
Gate-Drain Charge	Qgd		-	20.5	-	
Drain-Source crossover Charge	Qsw		-	8.5	-	

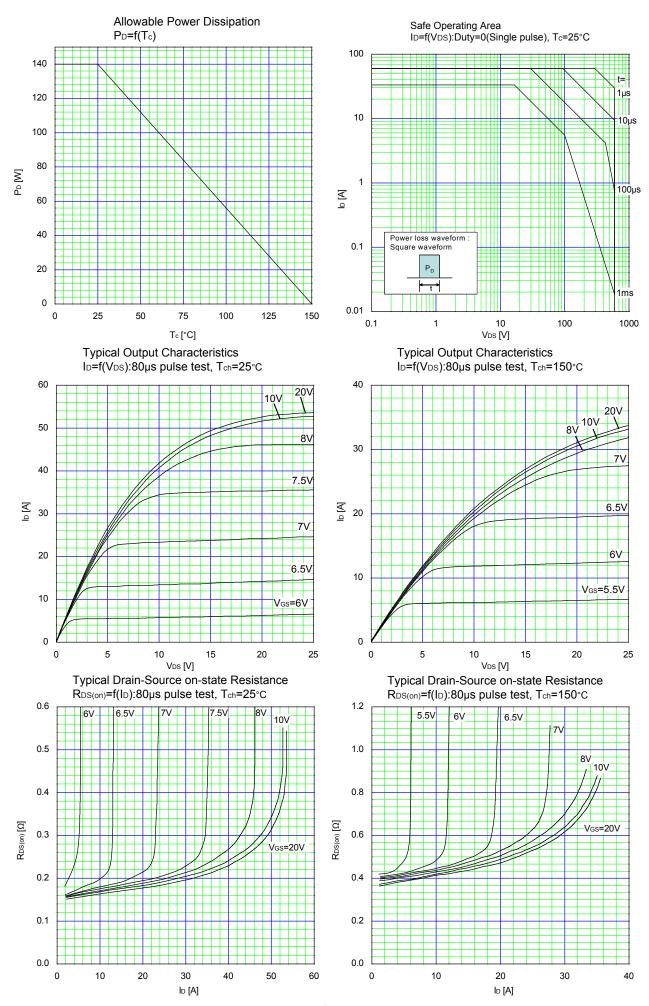
Note *6 : $C_{o(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 400V. Note *7 : $C_{o(tr)}$ is a fixed capacitance that gives the same charging times as C_{oss} while V_{DS} is rising from 0 to 400V.

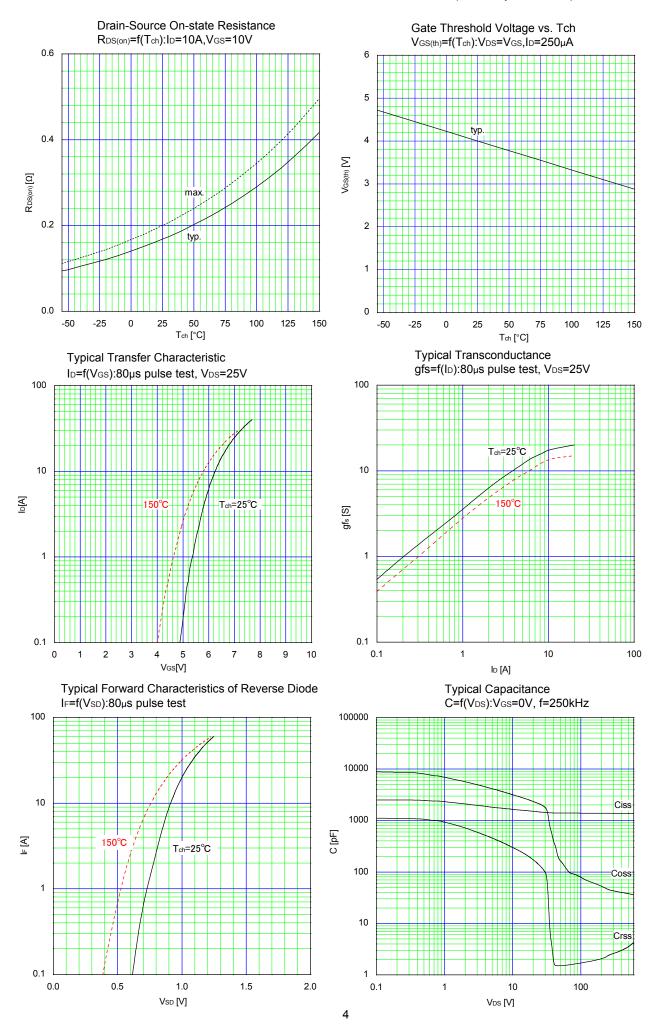
Reverse Diode

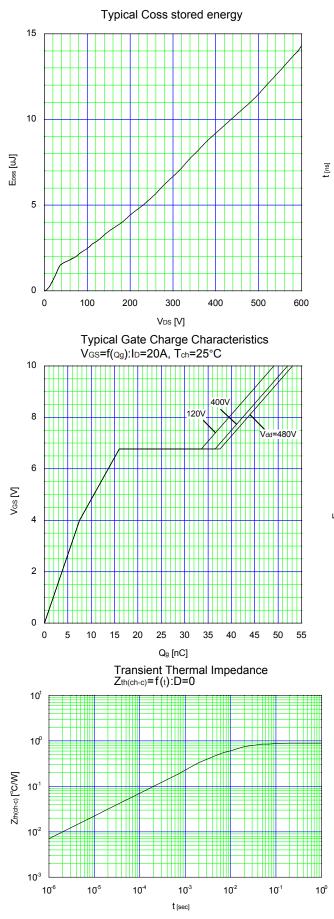
Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Avalanche Capability	lav	L=6.02mH,T₀+=25°C See Fig.1 and Fig.2	6.6	-	-	А
Diode Forward On-Voltage	V _{SD}	I⊧=20A,V₀s=0V T₀h=25°C	-	1	1.35	V
Reverse Recovery Time	trr	- I⊧=20A, V₀₀=400V -di/dt=100A/μs T₀+=25°C See Fig.6 and Fig.7	-	150	-	ns
Reverse Recovery Charge	Qrr		-	1	-	μC
Peak Reverse Recovery Current	Irp		-	13	-	А

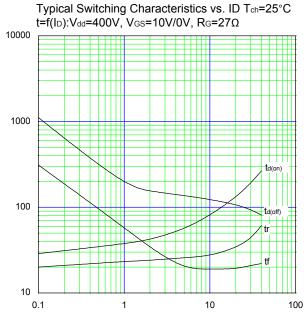
Thermal Resistance

Parameter	Symbol	min.	typ.	max.	Unit
Channel to Case	R _{th(ch-c)}	-	-	0.89	°C/W
Channel to Ambient	R _{th(ch-a)}	-	-	50	°C/W

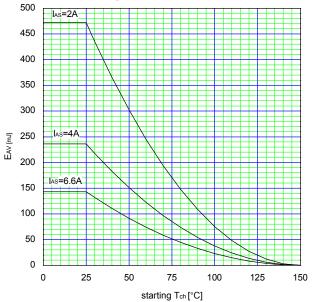








 $\label{eq:ld} \begin{array}{l} I_{D} \ [A] \\ Maximum \ Avalanche \ Energy \ vs. \ starting \ T_{ch} \\ E_{(AV)} = f_{(starting \ T_{ch})} \cdot Vcc = 60V, \ I_{(AV)} < = 6.6A \end{array}$



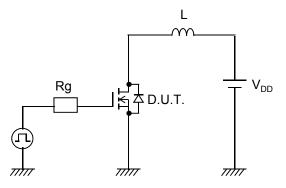


Fig.1 Avalanche Test circuit

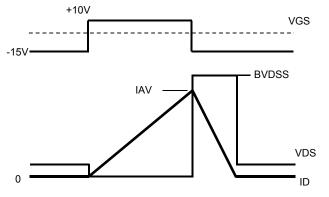


Fig.2 Operating waveforms of Avalanche Test

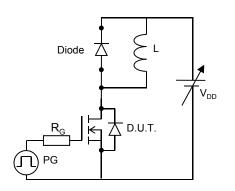


Fig.3 Switching Test circuit

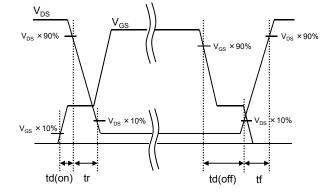


Fig.4 Operating waveform of Switching Test

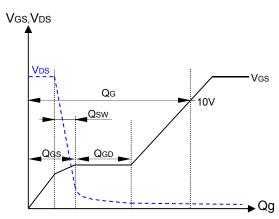
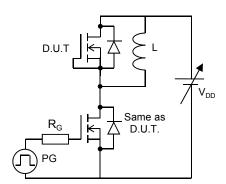


Fig.5 Operating waveform of Gate charge Test



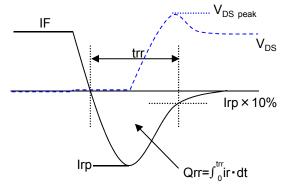
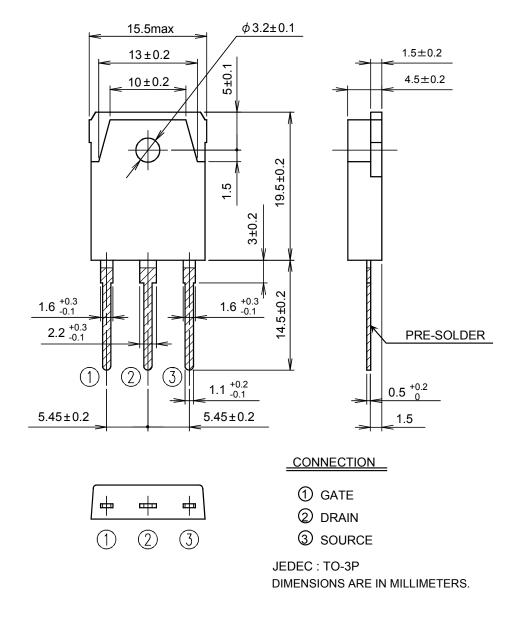


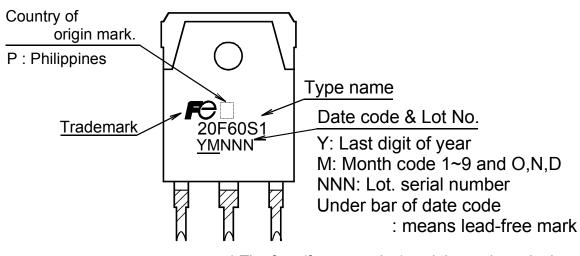
Fig.6 Reverse recovery Test circuit

Fig.7 Operating waveform of Reverse recovery Test

Outview: TO-3P Package



Marking



* The font (font type,size) and the trademark-size might be actually different.

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